



Product Change Notification

Change Notification #: 114705 - 00
Change Title: Intel® Dual Band Wireless-AC 8260
SKUs: 8260.D2WMLG;
8260.D2WMLG.NV; 8260.D2WMLG.S;
8260.D2WMLDNVS;
8260.D2WMLTGNVS;
8260.D2WMLTG.NV,
PCN 114705-00, Label, Manufacturing Site,
Label Update for additional site
Date of Publication: June 23, 2016

Key Characteristics of the Change:

Label, Manufacturing Site

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jul 01, 2016
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Description of Change to the Customer:

In order to ensure a continuous supply of the Intel® Dual Band Wireless-AC 8260 1216 solder down products listed in the "Products Affected" Table below, Intel will enable Gemtek (WDM4) as 2nd site for Sfp1216 product. Product line cert at Gemtek was completed in WW23. An equivalency report is provided.

As a result we are adding the Gemtek site code info to the packaging label.

WDM4 = CX

Example:

WDM4



WDM7



Customer Impact of Change and Recommended Action:

The Gemtek site code is being added to the packaging label as shown above. Top is the addition of Gemtek and below is current package and manufacturing site.

The changes to the products do not affect functionality. Intel anticipates no impact to customers.

Milestone dates are estimates and subject to change based on business and operational conditions. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#
8260.D2WMLG	942104
8260.D2WMLG.NV	942164
8260.D2WMLDNVS	944122
8260.D2WMLG.S	944454
8260.D2WMLTGNVS	947409
8260.D2WMLTG.NV	947410

PCN Revision History:

Date of Revision:

June 23, 2016

Revision Number:

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Reason:

Originally Published PCN



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114705 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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